Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	16MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	66
Program Memory Size	32KB (16K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	902 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 16x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-TQFP
Supplier Device Package	80-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c766t-16i-pt

4.2 Clocking Scheme/Instruction Cycle

The clock input (from OSC1) is internally divided by four to generate four non-overlapping quadrature clocks, namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1 and the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 4-8.

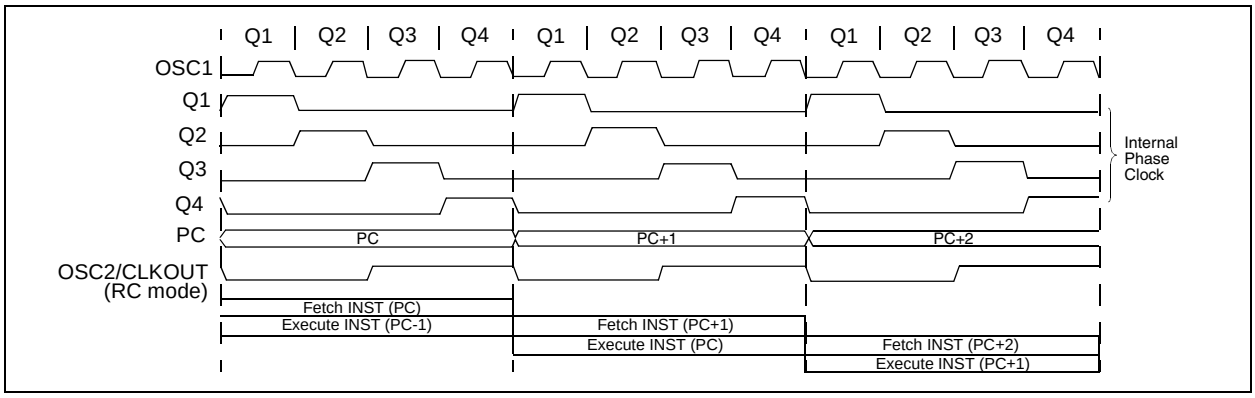
4.3 Instruction Flow/Pipelining

An “Instruction Cycle” consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle, while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g. `GOTO`), then two cycles are required to complete the instruction (Example 4-1).

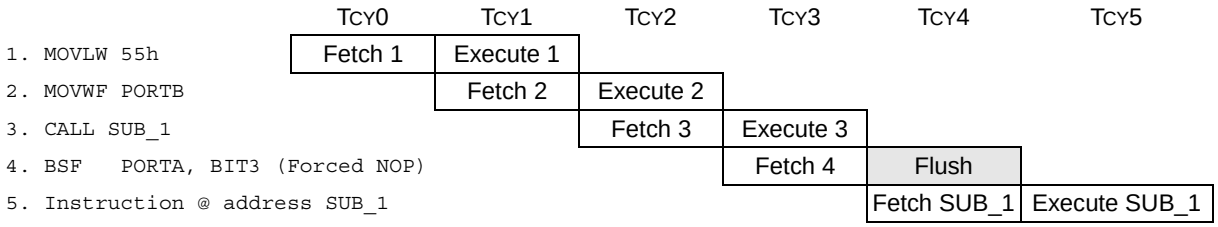
A fetch cycle begins with the program counter incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the “Instruction Register (IR)” in cycle Q1. This instruction is then decoded and executed during the Q2, Q3 and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 4-8: CLOCK/INSTRUCTION CYCLE



EXAMPLE 4-1: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetched instruction is “flushed” from the pipeline, while the new instruction is being fetched and then executed.

In Figure 5-5, Figure 5-6 and Figure 5-7, the TPWRT timer time-out is greater then the TOST timer time-out, as would be the case in higher frequency crystals. For lower frequency crystals (i.e., 32 kHz), TOST may be greater.

FIGURE 5-5: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ TIED TO VDD)

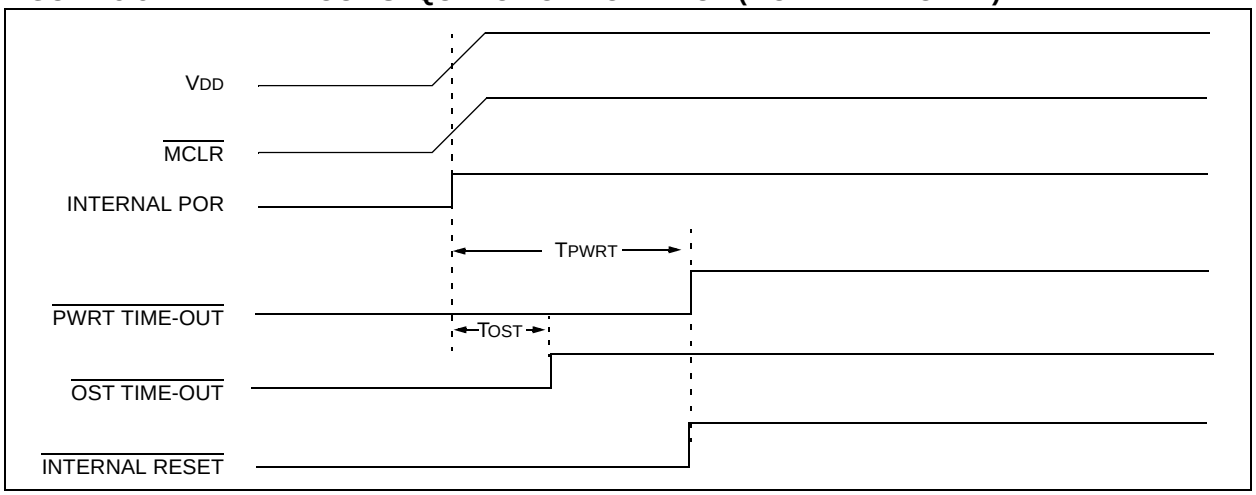


FIGURE 5-6: TIME-OUT SEQUENCE ON POWER-UP ($\overline{\text{MCLR}}$ NOT TIED TO VDD)

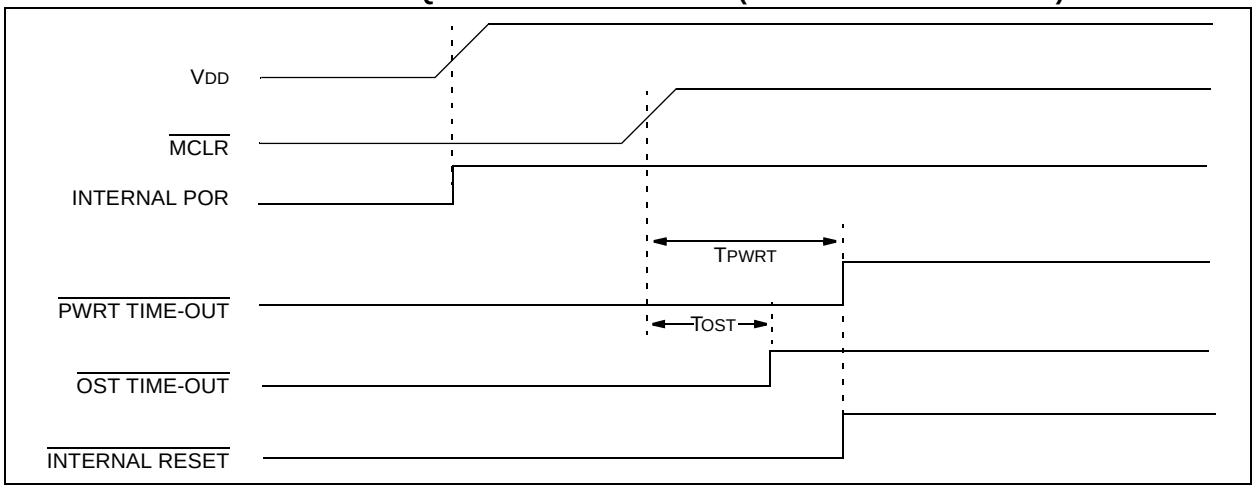


FIGURE 5-7: SLOW RISE TIME ($\overline{\text{MCLR}}$ TIED TO VDD)

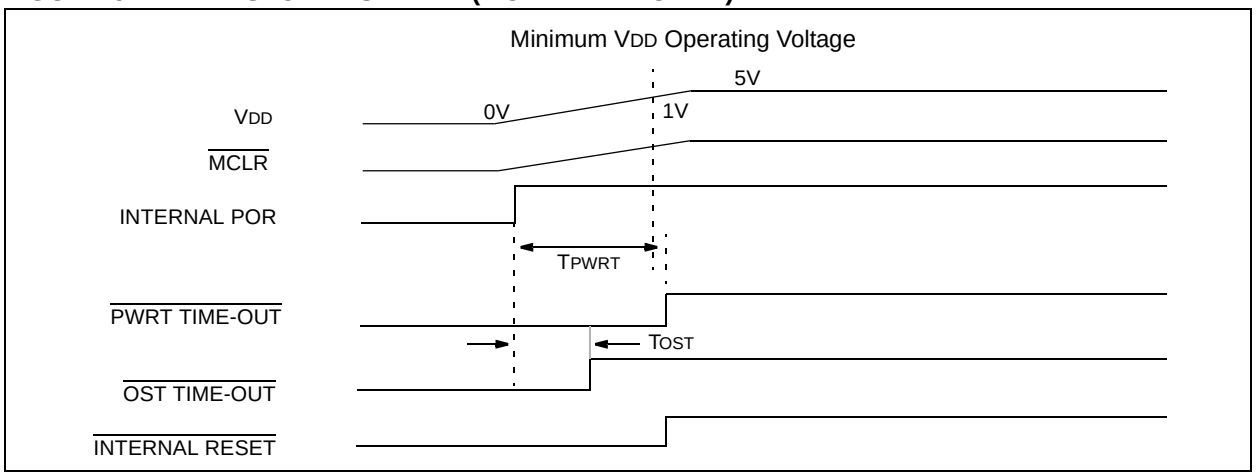


TABLE 5-4: INITIALIZATION CONDITIONS FOR SPECIAL FUNCTION REGISTERS (CONTINUED)

Register	Address	Power-on Reset Brown-out Reset	$\overline{\text{MCLR}}$ Reset WDT Reset	Wake-up from SLEEP through Interrupt
Bank 1				
DDRC(5)	10h	1111 1111	1111 1111	uuuu uuuu
PORTC(4,5)	11h	xxxx xxxx	uuuu uuuu	uuuu uuuu
DDRD(5)	12h	1111 1111	1111 1111	uuuu uuuu
PORTD(4,5)	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
DDRE(5)	14h	---- 1111	---- 1111	---- uuuu
PORTE(4,5)	15h	---- xxxx	---- uuuu	---- uuuu
PIR1	16h	x000 0010	u000 0010	uuuu uuuu(1)
PIE1	17h	0000 0000	0000 0000	uuuu uuuu
Bank 2				
TMR1	10h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR2	11h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3L	12h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3H	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PR1	14h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PR2	15h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PR3/CA1L	16h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PR3/CA1H	17h	xxxx xxxx	uuuu uuuu	uuuu uuuu
Bank 3				
PW1DCL	10h	xx-- ----	uu-- ----	uu-- ----
PW2DCL	11h	xx0- ----	uu0- ----	uuu- ----
PW1DCH	12h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PW2DCH	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
CA2L	14h	xxxx xxxx	uuuu uuuu	uuuu uuuu
CA2H	15h	xxxx xxxx	uuuu uuuu	uuuu uuuu
TCON1	16h	0000 0000	0000 0000	uuuu uuuu
TCON2	17h	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented, read as '0', q = value depends on condition

Note 1: One or more bits in INTSTA, PIR1, PIR2 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GLINTD bit is cleared, the PC is loaded with the interrupt vector.

3: See Table 5-3 for RESET value of specific condition.

4: This is the value that will be in the port output latch.

5: When the device is configured for Microprocessor or Extended Microcontroller mode, the operation of this port does not rely on these registers.

6: On any device RESET, these pins are configured as inputs.

5.1.5 BROWN-OUT RESET (BOR)

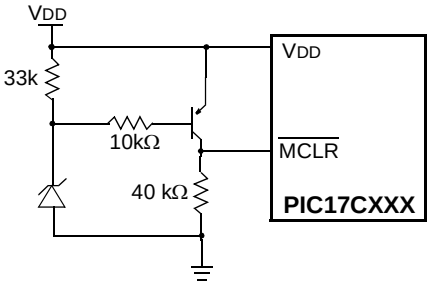
PIC17C7XX devices have on-chip Brown-out Reset circuitry. This circuitry places the device into a RESET when the device voltage falls below a trip point (BVDD). This ensures that the device does not continue program execution outside the valid operation range of the device. Brown-out Resets are typically used in AC line applications, or large battery applications, where large loads may be switched in (such as automotive).

Note:	Before using the on-chip Brown-out for a voltage supervisory function, please review the electrical specifications to ensure that they meet your requirements.

The BODEN configuration bit can disable (if clear/ programmed), or enable (if set) the Brown-out Reset circuitry. If VDD falls below BVDD (typically 4.0 V, paramter #D005 in electrical specification section), for greater than parameter #35, the Brown-out situation will reset the chip. A RESET is not guaranteed to occur if VDD falls below BVDD for less than paramter #35. The chip will remain in Brown-out Reset until VDD rises above BVDD. The Power-up Timer and Oscillator Start-up Timer will then be invoked. This will keep the chip in RESET the greater of 96 ms and 1024 TOSC. If VDD drops below BVDD while the Power-up Timer/Oscillator Start-up Timer is running, the chip will go back into a Brown-out Reset. The Power-up Timer/Oscillator Start-up Timer will be initialized. Once VDD rises above BVDD, the Power-up Timer/Oscillator Start-up Timer will start their time delays. Figure 5-10 shows typical Brown-out situations.

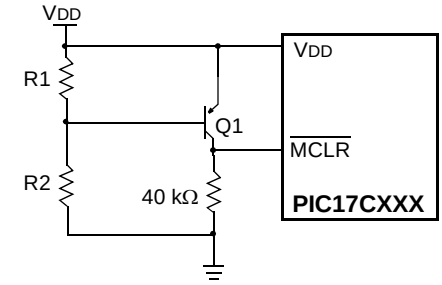
In some applications, the Brown-out Reset trip point of the device may not be at the desired level. Figure 5-8 and Figure 5-9 are two examples of external circuitry that may be implemented. Each needs to be evaluated to determine if they match the requirements of the application.

FIGURE 5-8: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



This circuit will activate RESET when VDD goes below (Vz + 0.7V) where Vz = Zener voltage.

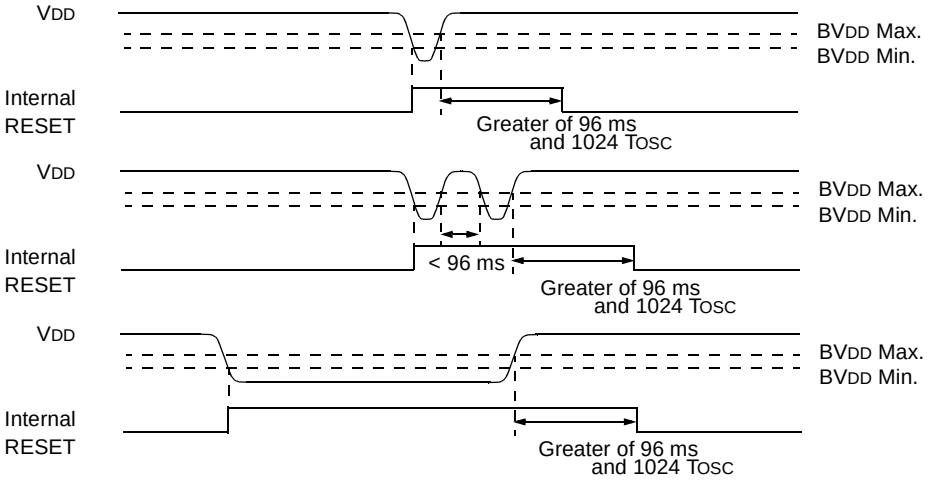
FIGURE 5-9: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \bullet \frac{R1}{R1 + R2} = 0.7V$$

FIGURE 5-10: BROWN-OUT SITUATIONS



NOTES:

6.1 Interrupt Status Register (INTSTA)

The Interrupt Status/Control register (INTSTA) contains the flag and enable bits for non-peripheral interrupts.

The PEIF bit is a read only, bit wise OR of all the peripheral flag bits in the PIR registers (Figure 6-4 and Figure 6-5).

Note:	All interrupt flag bits get set by their specified condition, even if the corresponding interrupt enable bit is clear (interrupt disabled), or the GLINTD bit is set (all interrupts disabled).

Care should be taken when clearing any of the INTSTA register enable bits when interrupts are enabled (GLINTD is clear). If any of the INTSTA flag bits (T0IF, INTF, T0CKIF, or PEIF) are set in the same instruction cycle as the corresponding interrupt enable bit is cleared, the device will vector to the RESET address (0x00).

Prior to disabling any of the INTSTA enable bits, the GLINTD bit should be set (disabled).

REGISTER 6-1: INTSTA REGISTER (ADDRESS: 07h, UNBANKED)

R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PEIF	T0CKIF	T0IF	INTF	PEIE	T0CKIE	T0IE	INTE
bit 7							bit 0

bit 7 **PEIF**: Peripheral Interrupt Flag bit
This bit is the OR of all peripheral interrupt flag bits AND'ed with their corresponding enable bits. The interrupt logic forces program execution to address (20h) when a peripheral interrupt is pending.
1 = A peripheral interrupt is pending
0 = No peripheral interrupt is pending

bit 6 **T0CKIF**: External Interrupt on T0CKI Pin Flag bit
This bit is cleared by hardware, when the interrupt logic forces program execution to address (18h).
1 = The software specified edge occurred on the RA1/T0CKI pin
0 = The software specified edge did not occur on the RA1/T0CKI pin

bit 5 **T0IF**: TMR0 Overflow Interrupt Flag bit
This bit is cleared by hardware, when the interrupt logic forces program execution to address (10h).
1 = TMR0 overflowed
0 = TMR0 did not overflow

bit 4 **INTF**: External Interrupt on INT Pin Flag bit
This bit is cleared by hardware, when the interrupt logic forces program execution to address (08h).
1 = The software specified edge occurred on the RA0/INT pin
0 = The software specified edge did not occur on the RA0/INT pin

bit 3 **PEIE**: Peripheral Interrupt Enable bit
This bit acts as a global enable bit for the peripheral interrupts that have their corresponding enable bits set.
1 = Enable peripheral interrupts
0 = Disable peripheral interrupts

bit 2 **T0CKIE**: External Interrupt on T0CKI Pin Enable bit
1 = Enable software specified edge interrupt on the RA1/T0CKI pin
0 = Disable interrupt on the RA1/T0CKI pin

bit 1 **T0IE**: TMR0 Overflow Interrupt Enable bit
1 = Enable TMR0 overflow interrupt
0 = Disable TMR0 overflow interrupt

bit 0 **INTE**: External Interrupt on RA0/INT Pin Enable bit
1 = Enable software specified edge interrupt on the RA0/INT pin
0 = Disable software specified edge interrupt on the RA0/INT pin

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR Reset	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

7.2.2.2 CPU Status Register (CPUSTA)

The CPUSTA register contains the status and control bits for the CPU. This register has a bit that is used to globally enable/disable interrupts. If only a specific interrupt is desired to be enabled/disabled, please refer to the Interrupt Status (INTSTA) register and the Peripheral Interrupt Enable (PIE) registers. The CPUSTA register also indicates if the stack is available and contains the Power-down ($\overline{PD}$) and Time-out ($\overline{TO}$) bits. The $\overline{TO}$, $\overline{PD}$, and STKAV bits are not writable. These bits are set and cleared according to device logic. Therefore, the result of an instruction with the CPUSTA register as destination may be different than intended.

The $\overline{POR}$ bit allows the differentiation between a Power-on Reset, external $\overline{MCLR}$ Reset, or a WDT Reset. The $\overline{BOR}$ bit indicates if a Brown-out Reset occurred.

Note 1:	The $\overline{BOR}$ status bit is a don't care and is not necessarily predictable if the Brown-out circuit is disabled (when the BODEN bit in the Configuration word is programmed).

REGISTER 7-2: CPUSTA REGISTER (ADDRESS: 06h, UNBANKED)

U-0	U-0	R-1	R/W-1	R-1	R-1	R/W-0	R/W-1
—	—	STKAV	GLINTD	$\overline{TO}$	$\overline{PD}$	$\overline{POR}$	$\overline{BOR}$
bit 7							bit 0

bit 7-6 **Unimplemented**: Read as '0'

bit 5 **STKAV**: Stack Available bit
This bit indicates that the 4-bit stack pointer value is Fh, or has rolled over from Fh → 0h (stack overflow).
1 = Stack is available
0 = Stack is full, or a stack overflow may have occurred (once this bit has been cleared by a stack overflow, only a device RESET will set this bit)

bit 4 **GLINTD**: Global Interrupt Disable bit
This bit disables all interrupts. When enabling interrupts, only the sources with their enable bits set can cause an interrupt.
1 = Disable all interrupts
0 = Enables all unmasked interrupts

bit 3 **$\overline{TO}$**: WDT Time-out Status bit
1 = After power-up, by a CLRWDT instruction, or by a SLEEP instruction
0 = A Watchdog Timer time-out occurred

bit 2 **$\overline{PD}$**: Power-down Status bit
1 = After power-up or by the CLRWDT instruction
0 = By execution of the SLEEP instruction

bit 1 **$\overline{POR}$**: Power-on Reset Status bit
1 = No Power-on Reset occurred
0 = A Power-on Reset occurred (must be set by software)

bit 0 **$\overline{BOR}$**: Brown-out Reset Status bit

When BODEN Configuration bit is set (enabled):
1 = No Brown-out Reset occurred
0 = A Brown-out Reset occurred (must be set by software)

When BODEN Configuration bit is clear (disabled):
Don't care

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR Reset	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

8.3 Table Reads

The table read allows the program memory to be read. This allows constants to be stored in the program memory space and retrieved into data memory when needed. Example 8-2 reads the 16-bit value at program memory address TBLPTR. After the dummy byte has been read from the TABLATH, the TABLATH is loaded with the 16-bit data from program memory address TBLPTR and then increments the TBLPTR value. The first read loads the data into the latch and can be considered a dummy read (unknown data loaded into 'f'). INDF0 should be configured for either auto-increment or auto-decrement.

EXAMPLE 8-2: TABLE READ

```
MOVLW   HIGH (TBL_ADDR) ; Load the Table
MOVWF   TBLPTRH         ;   address
MOVLW   LOW (TBL_ADDR)  ;
MOVWF   TBLPTRL         ;
TABLRD  0, 1, DUMMY   ; Dummy read,
                      ;  Updates TABLATH
                      ;  Increments TBLPTR
TLRD    1, INDF0      ; Read HI byte
                      ;   of TABLATH
TABLRD  0, 1, INDF0   ; Read LO byte
                      ;   of TABLATL and
                      ;   Update TABLATH
                      ;   Increment TBLPTR
```

FIGURE 8-7: `TABLRD` TIMING

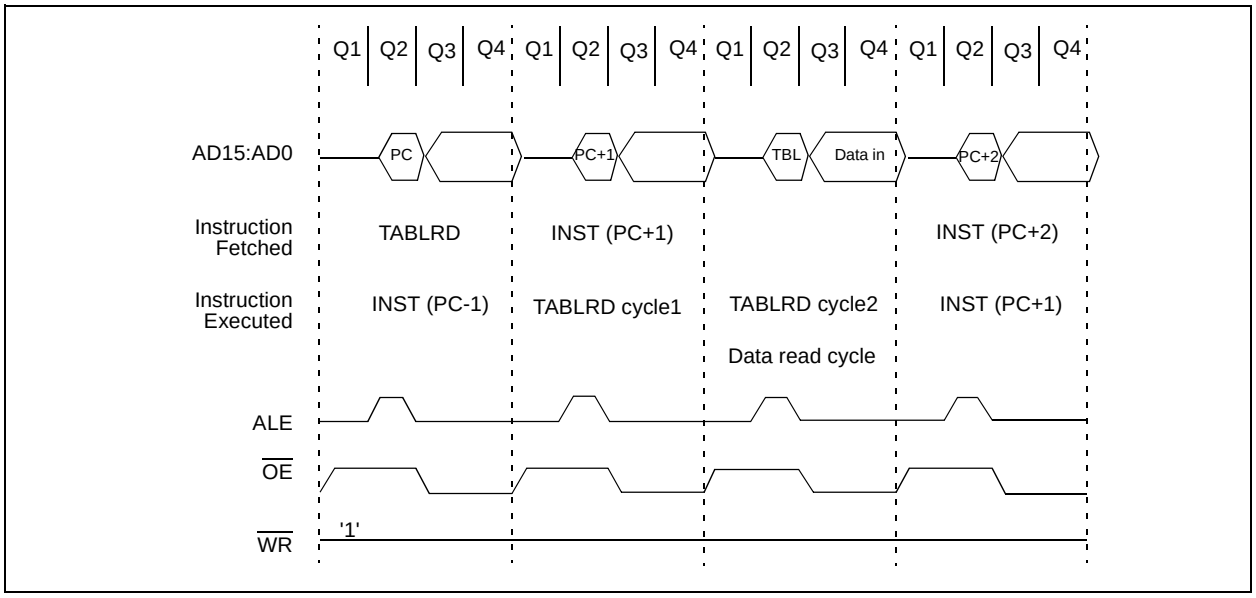
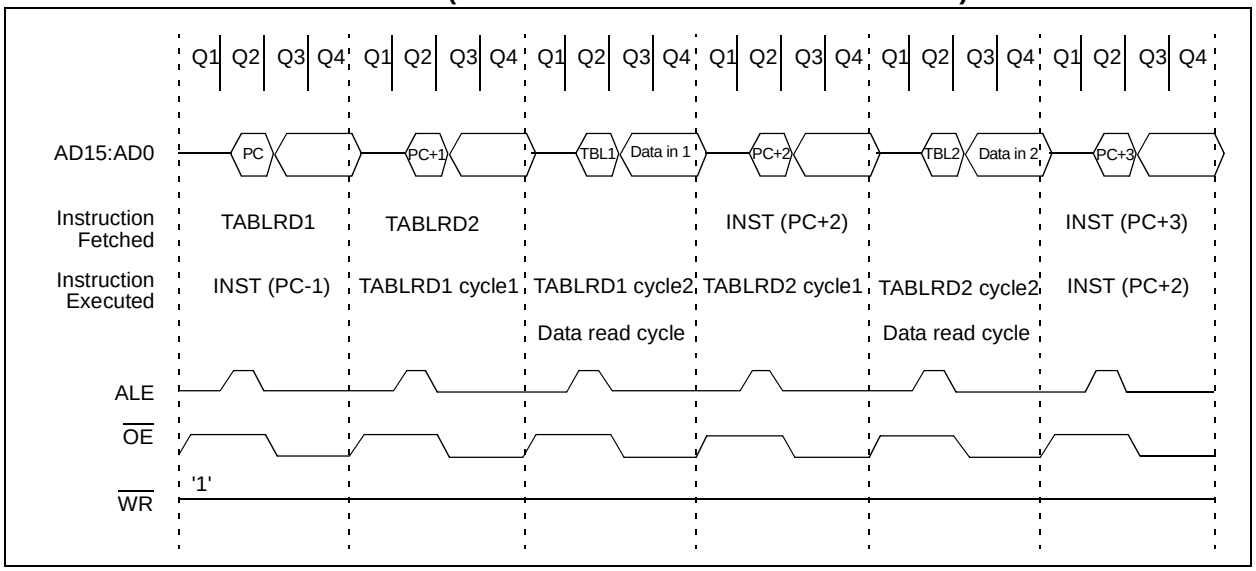


FIGURE 8-8: `TABLRD` TIMING (CONSECUTIVE `TABLRD` INSTRUCTIONS)



REGISTER 13-2: TCON2 REGISTER (ADDRESS: 17h, BANK 3)

R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CA2OVF	CA1OVF	PWM2ON	PWM1ON	CA1/$\overline{PR3}$	TMR3ON	TMR2ON	TMR1ON
bit 7							bit 0

bit 7 **CA2OVF**: Capture2 Overflow Status bit
This bit indicates that the capture value had not been read from the capture register pair (CA2H:CA2L) before the next capture event occurred. The capture register retains the oldest unread capture value (last capture before overflow). Subsequent capture events will not update the capture register with the TMR3 value until the capture register has been read (both bytes).
1 = Overflow occurred on Capture2 register
0 = No overflow occurred on Capture2 register

bit 6 **CA1OVF**: Capture1 Overflow Status bit
This bit indicates that the capture value had not been read from the capture register pair (PR3H/CA1H:PR3L/CA1L), before the next capture event occurred. The capture register retains the oldest unread capture value (last capture before overflow). Subsequent capture events will not update the capture register with the TMR3 value until the capture register has been read (both bytes).
1 = Overflow occurred on Capture1 register
0 = No overflow occurred on Capture1 register

bit 5 **PWM2ON**: PWM2 On bit
1 = PWM2 is enabled
(The RB3/PWM2 pin ignores the state of the DDRB<3> bit.)
0 = PWM2 is disabled
(The RB3/PWM2 pin uses the state of the DDRB<3> bit for data direction.)

bit 4 **PWM1ON**: PWM1 On bit
1 = PWM1 is enabled
(The RB2/PWM1 pin ignores the state of the DDRB<2> bit.)
0 = PWM1 is disabled
(The RB2/PWM1 pin uses the state of the DDRB<2> bit for data direction.)

bit 3 **CA1/$\overline{PR3}$**: CA1/$\overline{PR3}$ Register Mode Select bit
1 = Enables Capture1
(PR3H/CA1H:PR3L/CA1L is the Capture1 register. Timer3 runs without a period register.)
0 = Enables the Period register
(PR3H/CA1H:PR3L/CA1L is the Period register for Timer3.)

bit 2 **TMR3ON**: Timer3 On bit
1 = Starts Timer3
0 = Stops Timer3

bit 1 **TMR2ON**: Timer2 On bit
This bit controls the incrementing of the TMR2 register. When TMR2:TMR1 form the 16-bit timer (T16 is set), TMR2ON must be set. This allows the MSB of the timer to increment.
1 = Starts Timer2 (must be enabled if the T16 bit (TCON1<3>) is set)
0 = Stops Timer2

bit 0 **TMR1ON**: Timer1 On bit

When T16 is set (in 16-bit Timer mode):
1 = Starts 16-bit TMR2:TMR1
0 = Stops 16-bit TMR2:TMR1

When T16 is clear (in 8-bit Timer mode:
1 = Starts 8-bit Timer1
0 = Stops 8-bit Timer1

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR Reset	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

15.1.4 MASTER MODE

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2, Figure 15-5) is to broadcast data by the software protocol.

In Master mode, the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SDO output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a “Line Activity Monitor” mode.

The clock polarity is selected by appropriately programming bit CKP (SSPCON1<4>). This then, would give waveforms for SPI communication as shown in Figure 15-6, Figure 15-8 and Figure 15-9, where the MSb is transmitted first. In Master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- FOSC/4 (or TCY)
- FOSC/16 (or 4 • TCY)
- FOSC/64 (or 16 • TCY)
- Timer2 output/2

This allows a maximum bit clock frequency (at 33 MHz) of 8.25 MHz.

Figure 15-6 shows the waveforms for Master mode. When CKE = 1, the SDO data is valid before there is a clock edge on SCK. The change of the input sample is shown based on the state of the SMP bit. The time when the SSPBUF is loaded with the received data is shown.

FIGURE 15-6: SPI MODE WAVEFORM (MASTER MODE)

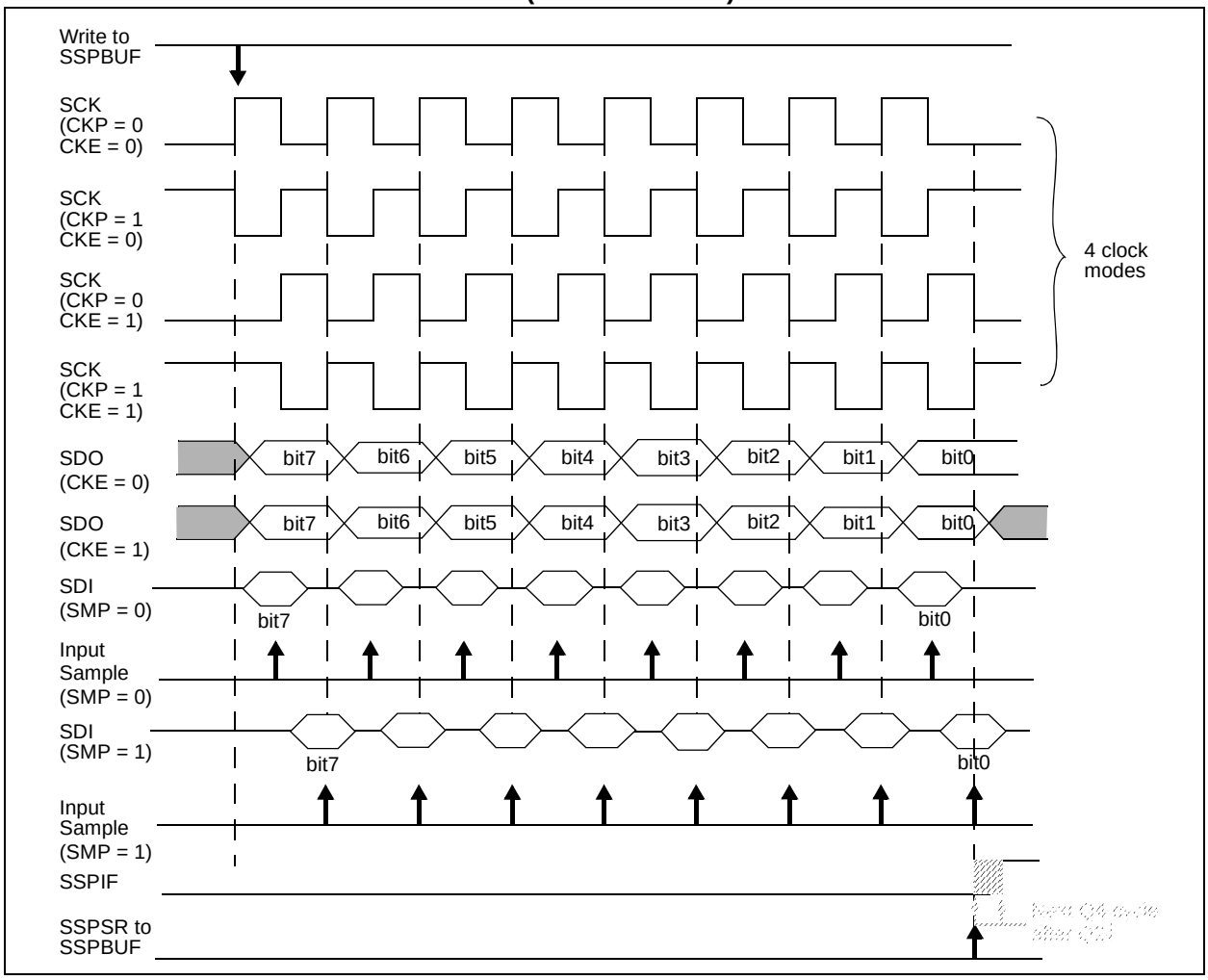
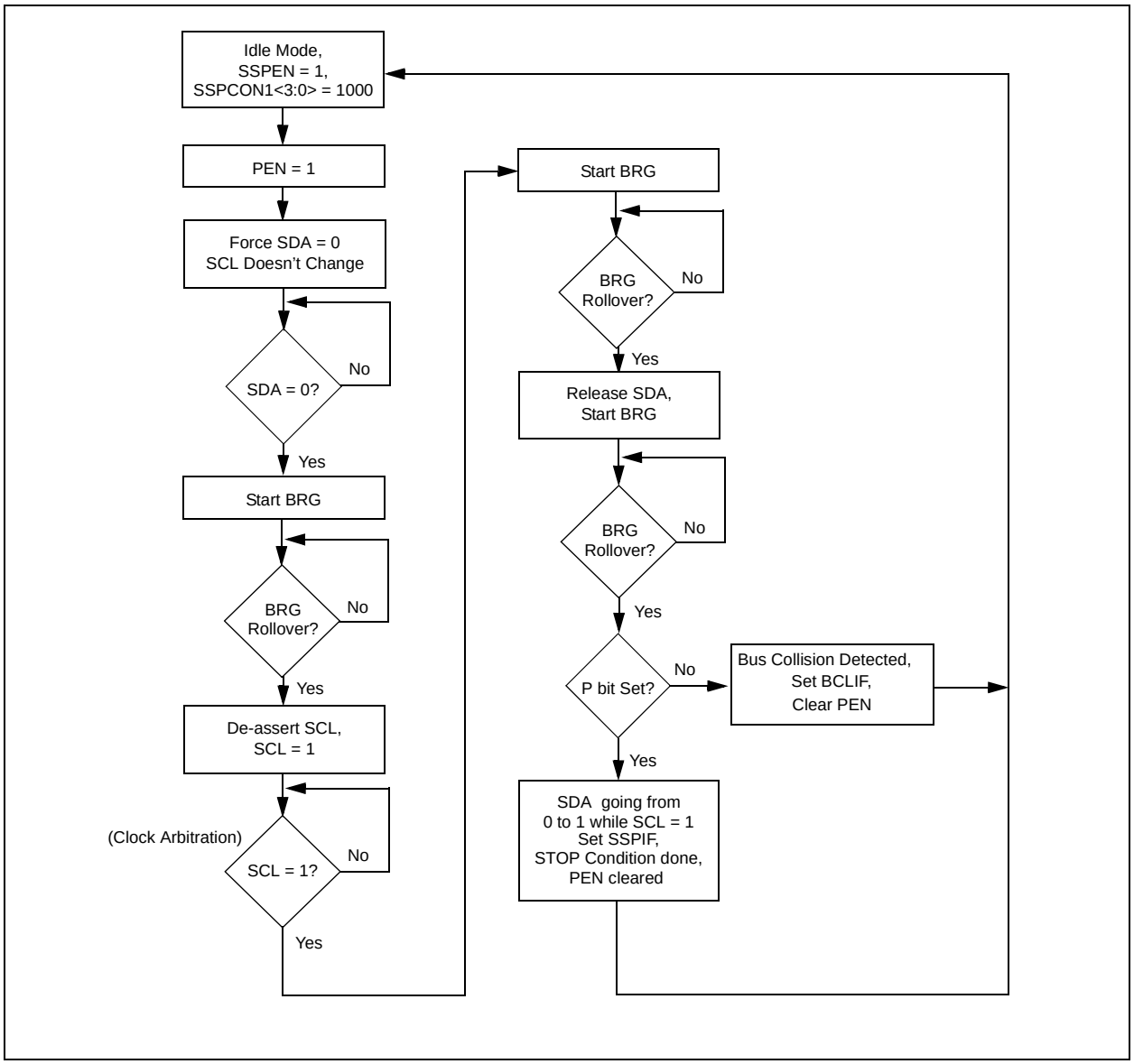


FIGURE 15-32: STOP CONDITION FLOW CHART



15.2.15 CLOCK ARBITRATION

Clock arbitration occurs when the master, during any receive, transmit, or Repeated Start/Stop condition, deasserts the SCL pin (SCL allowed to float high). When the SCL pin is allowed to float high, the baud rate generator (BRG) is suspended from counting until the SCL pin is actually sampled high. When the SCL pin is sampled high, the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. This ensures that the SCL high time will always be at least one BRG rollover count, in the event that the clock is held low by an external device (Figure 15-33).

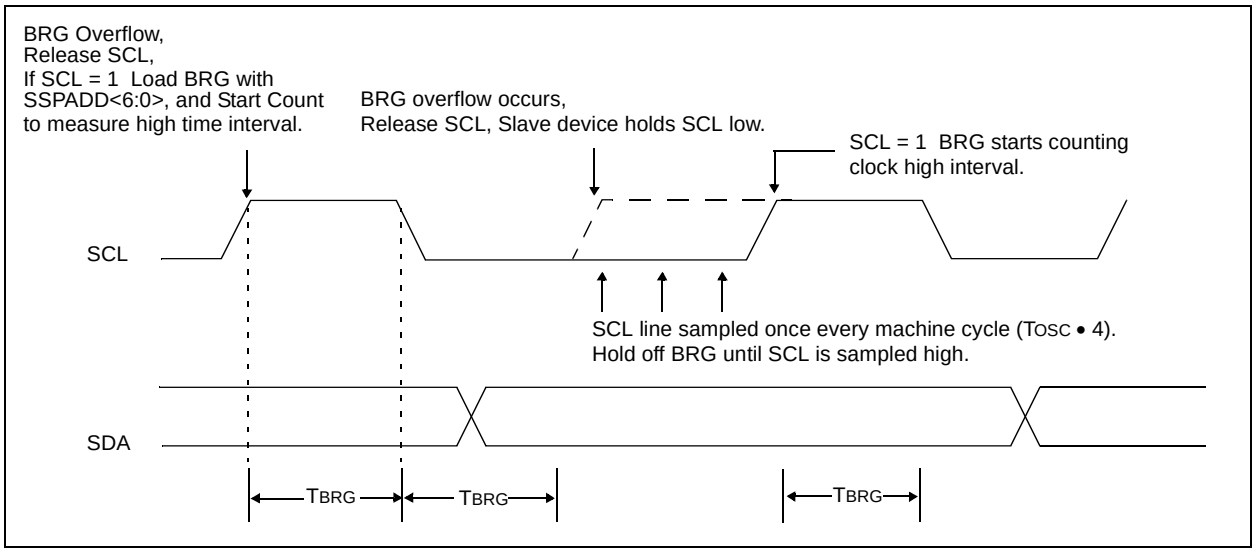
15.2.16 SLEEP OPERATION

While in SLEEP mode, the I^2C module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from SLEEP (if the SSP interrupt is enabled).

15.2.17 EFFECTS OF A RESET

A RESET disables the SSP module and terminates the current transfer.

FIGURE 15-33: CLOCK ARBITRATION TIMING IN MASTER TRANSMIT MODE



17.4.2 MINIMIZING CURRENT CONSUMPTION

To minimize current consumption, all I/O pins should be either at VDD, or VSS, with no external circuitry drawing current from the I/O pin. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The T0CKI input should be at VDD or VSS. The contributions from on-chip pull-ups on PORTB should also be considered and disabled, when possible.

17.5 Code Protection

The code in the program memory can be protected by selecting the microcontroller in Code Protected mode (PM2:PM0 = '000').

In this mode, instructions that are in the on-chip program memory space, can continue to read or write the program memory. An instruction that is executed outside of the internal program memory range will be inhibited from writing to, or reading from, program memory.

Note:	Microchip does not recommend code protecting windowed devices.

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

MOVPF **Move p to f**

Syntax: [*label*] MOVPF p,f

Operands: $0 \le f \le 255$
$0 \le p \le 31$

Operation: (p) → (f)

Status Affected: Z

Encoding:

010p	pppp	ffff	ffff

Description: Move data from data memory location 'p' to data memory location 'f'. Location 'f' can be anywhere in the 256 byte data space (00h to FFh), while 'p' can be 00h to 1Fh.

Either 'p' or 'f' can be WREG (a useful, special situation).

MOVPF is particularly useful for transferring a peripheral register (e.g. the timer or an I/O port) to a data memory location. Both 'f' and 'p' can be indirectly addressed.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'p'	Process Data	Write register 'f'

Example:
```
MOVPF   REG1, REG2
```
Before Instruction
REG1 = 0x11
REG2 = 0x33

After Instruction
REG1 = 0x11
REG2 = 0x11

MOVWF **Move WREG to f**

Syntax: [*label*] MOVWF f

Operands: $0 \le f \le 255$

Operation: (WREG) → (f)

Status Affected: None

Encoding:

0000	0001	ffff	ffff

Description: Move data from WREG to register 'f'. Location 'f' can be anywhere in the 256 byte data space.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example:
```
MOVWF   REG
```
Before Instruction
WREG = 0x4F
REG = 0xFF

After Instruction
WREG = 0x4F
REG = 0x4F

19.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can also link relocatable objects from pre-compiled libraries, using directives from a linker script.

The MPLIB object librarian is a librarian for pre-compiled code to be used with the MPLINK object linker. When a routine from a library is called from another source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications. The MPLIB object librarian manages the creation and modification of library files.

The MPLINK object linker features include:

- Integration with MPASM assembler and MPLAB C17 and MPLAB C18 C compilers.
- Allows all memory areas to be defined as sections to provide link-time flexibility.

The MPLIB object librarian features include:

- Easier linking because single libraries can be included instead of many smaller files.
- Helps keep code maintainable by grouping related modules together.
- Allows libraries to be created and modules to be added, listed, replaced, deleted or extracted.

19.5 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC-hosted environment by simulating the PIC series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user-defined key press, to any of the pins. The execution can be performed in single step, execute until break, or trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and the MPLAB C18 C compilers and the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent multi-project software development tool.

19.6 MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE

The MPLAB ICE universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC microcontrollers (MCUs). Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment (IDE), which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PIC microcontrollers.

The MPLAB ICE in-circuit emulator system has been designed as a real-time emulation system, with advanced features that are generally found on more expensive development tools. The PC platform and Microsoft® Windows environment were chosen to best make these features available to you, the end user.

19.7 ICEPIC In-Circuit Emulator

The ICEPIC low cost, in-circuit emulator is a solution for the Microchip Technology PIC16C5X, PIC16C6X, PIC16C7X and PIC16CXXX families of 8-bit One-Time-Programmable (OTP) microcontrollers. The modular system can support different subsets of PIC16C5X or PIC16CXXX products through the use of interchangeable personality modules, or daughter boards. The emulator is capable of emulating without target application circuitry being present.

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C for extended -40°C ≤ TA ≤ +85°C for industrial 0°C ≤ TA ≤ +70°C for commercial Operating voltage VDD range as described in Section 20.1				
Param. No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
D150	VOD	**Open Drain High Voltage**	–	–	8.5	V	RA2 and RA3 pins only pulled up to externally applied voltage
		Capacitive Loading Specs on Output Pins					
D100	COSC2	OSC2/CLKOUT pin	–	–	25	pF	In EC or RC osc modes, when OSC2 pin is outputting CLKOUT. External clock is used to drive OSC1.
D101	CIO	All I/O pins and OSC2 (in RC mode)	–	–	50	pF	
D102	CAD	System Interface Bus (PORTC, PORTD and PORTE)	–	–	50	pF	In Microprocessor or Extended Microcontroller mode
		Internal Program Memory Programming Specs (Note 4)					
D110	VPP	Voltage on MCLR/VPP pin	12.75	–	13.25	V	**(Note 5)**
D111	VDDP	Supply voltage during programming	4.75	5.0	5.25	V	
D112	IPP	Current into MCLR/VPP pin	–	25	50	mA	
D113	IDDP	Supply current during programming	–	–	30	mA	
D114	TPROG	Programming pulse width	100	–	1000	ms	Terminated via internal/ external interrupt or a RESET

† Data in "Typ" column is at 5V, 25°C unless otherwise stated.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC17CXXX devices be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

4: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in: PIC17C7XX Programming Specifications (Literature number DS TBD).

5: The MCLR/VPP pin may be kept in this range at times other than programming, but is not recommended.

6: For TTL buffers, the better of the two specifications may be used.

Note 1: When using the Table Write for internal programming, the device temperature must be less than 40°C.

2: For In-Circuit Serial Programming (ICSP™), refer to the device programming specification.

FIGURE 20-25: MEMORY INTERFACE READ TIMING

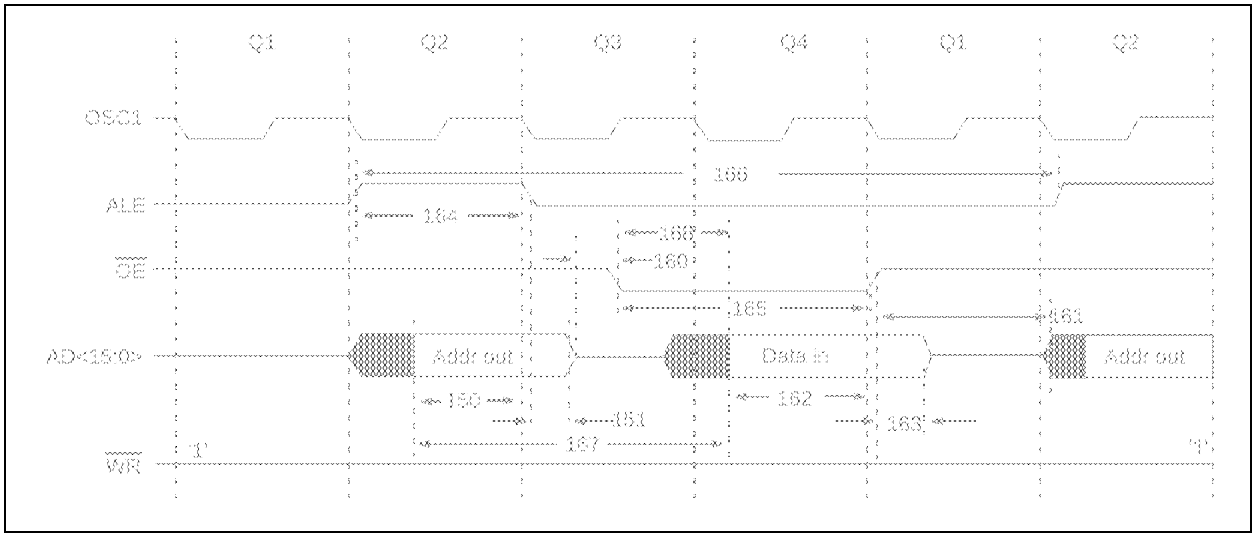


TABLE 20-21: MEMORY INTERFACE READ REQUIREMENTS

Param. No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
150	TadV2alL	AD15:AD0 (address) valid to ALE↓ (address setup time)	PIC17**C**XXX	0.25TCY - 10	—	—	ns	
			PIC17**LC**XXX	0.25TCY - 10	—	—		
151	TalL2adI	ALE↓ to address out invalid (address hold time)	PIC17**C**XXX	5	—	—	ns	
			PIC17**LC**XXX	5	—	—		
160	TadZ2oeL	AD15:AD0 hi-impedance to $\overline{OE}$↓	PIC17**C**XXX	0	—	—	ns	
			PIC17**LC**XXX	0	—	—		
161	ToeH2adD	$\overline{OE}$↑ to AD15:AD0 driven	PIC17**C**XXX	0.25TCY - 15	—	—	ns	
			PIC17**LC**XXX	0.25TCY - 15	—	—		
162	TadV2oeH	Data in valid before $\overline{OE}$↑ (data setup time)	PIC17**C**XXX	35	—	—	ns	
			PIC17**LC**XXX	45	—	—		
163	ToeH2adI	$\overline{OE}$↑to data in invalid (data hold time)	PIC17**C**XXX	0	—	—	ns	
			PIC17**LC**XXX	0	—	—		
164	TalH	ALE pulse width	PIC17**C**XXX	—	0.25TCY	—	ns	
			PIC17**LC**XXX	—	0.25TCY	—		
165	ToeL	$\overline{OE}$ pulse width	PIC17**C**XXX	0.5TCY - 35	—	—	ns	
			PIC17**LC**XXX	0.5TCY - 35	—	—		
166	TalH2alH	ALE↑ to ALE↑(cycle time)	PIC17**C**XXX	—	TCY	—	ns	
			PIC17**LC**XXX	—	TCY	—		
167	Tacc	Address access time	PIC17**C**XXX	—	—	0.75TCY - 30	ns	
			PIC17**LC**XXX	—	—	0.75TCY - 45		
168	Toe	Output enable access time ($\overline{OE}$ low to data valid)	PIC17**C**XXX	—	—	0.5TCY - 45	ns	
			PIC17**LC**XXX	—	—	0.5TCY - 75		

† Data in "Typ" column is at 5V, 25°C unless otherwise stated.

FIGURE 21-17: TYPICAL, MINIMUM AND MAXIMUM V_{OH} vs. I_{OH} (V_{DD} = 5V, -40°C TO +125°C)

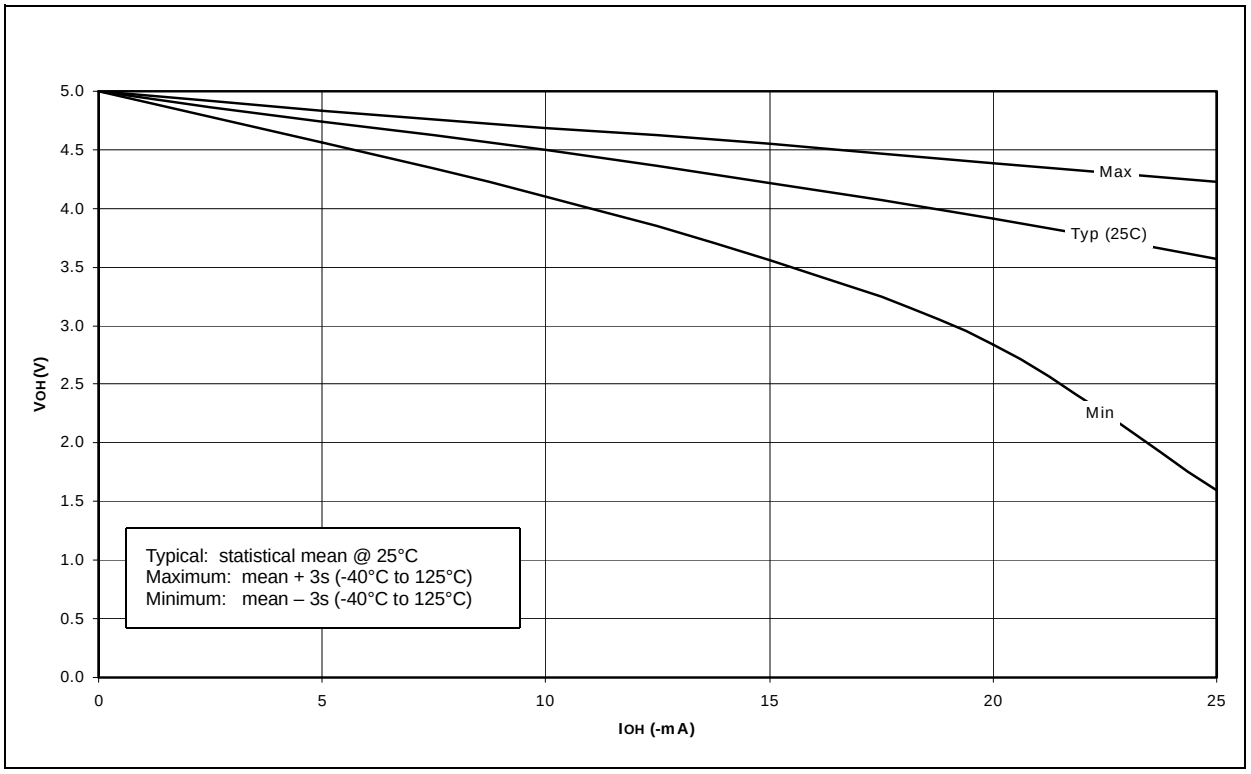
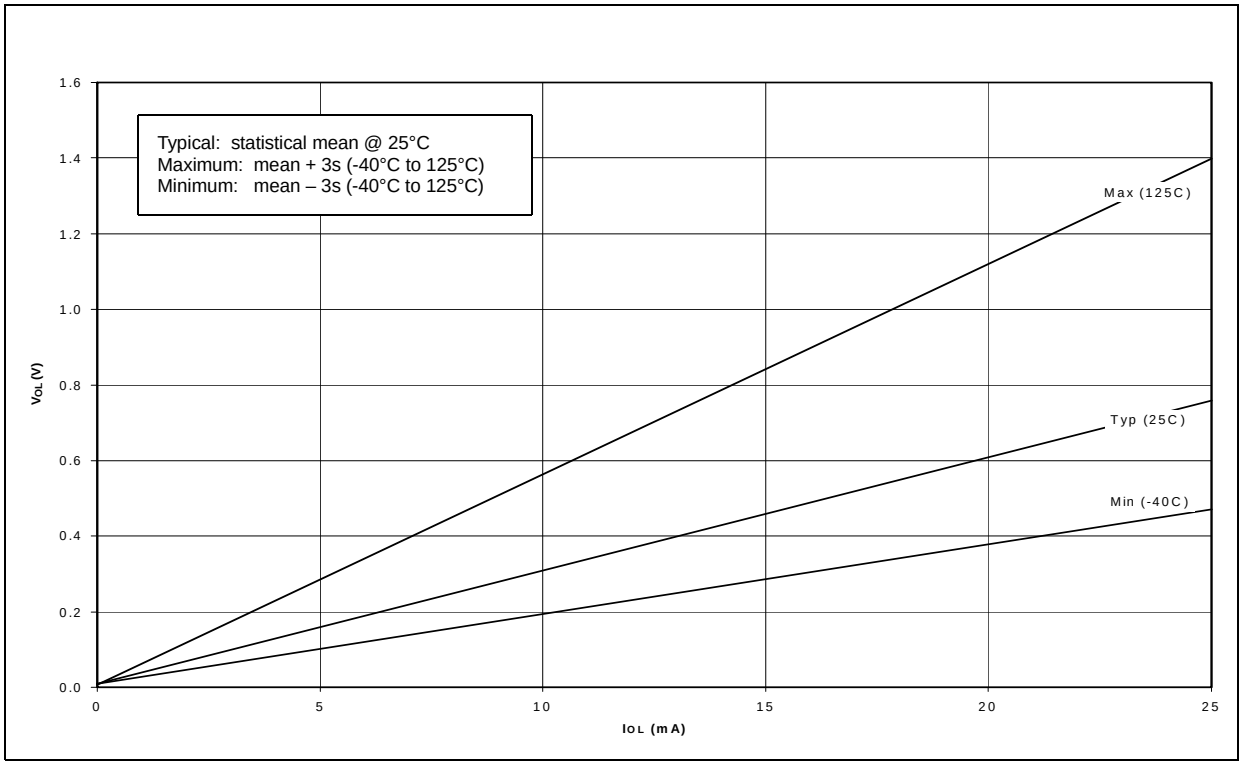
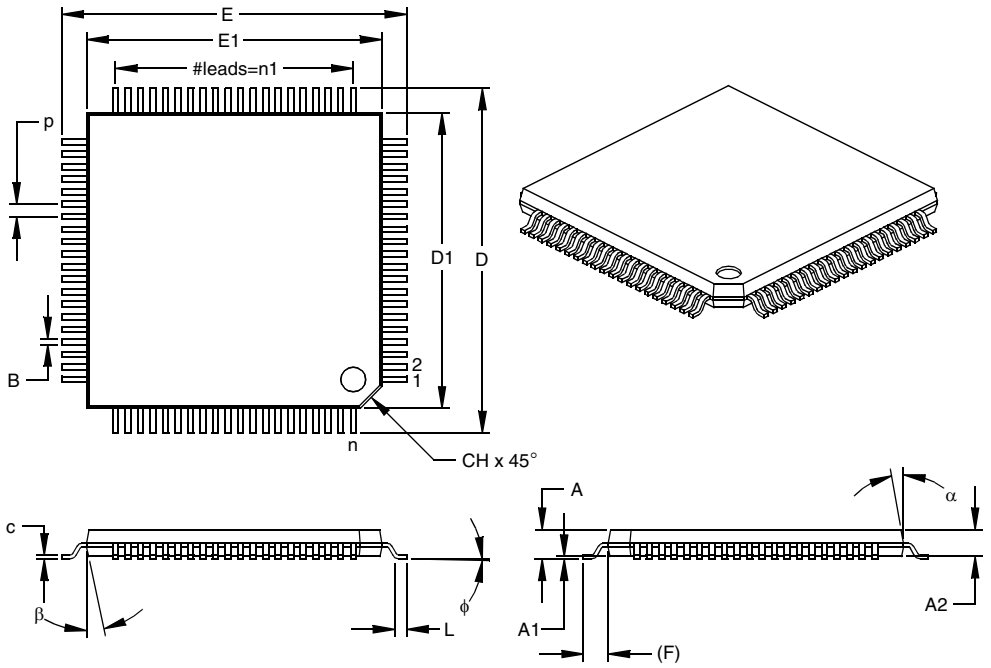


FIGURE 21-18: TYPICAL, MINIMUM AND MAXIMUM V_{OL} vs. I_{OL} (V_{DD} = 5V, -40°C TO +125°C)



80-Lead Plastic Thin Quad Flatpack (PT) 12x12x1 mm Body, 1.0/0.10 mm Lead Form (TQFP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES			MILLIMETERS*		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		80			80	
Pitch	p		.020			0.50	
Pins per Side	n1		20			20	
Overall Height	A	.039	.043	.047	1.00	1.10	1.20
Molded Package Thickness	A2	.037	.039	.041	0.95	1.00	1.05
Standoff §	A1	.002	.004	.006	0.05	0.10	0.15
Foot Length	L	.018	.024	.030	0.45	0.60	0.75
Footprint (Reference)	(F)		.039			1.00	
Foot Angle	ϕ	0	3.5	7	0	3.5	7
Overall Width	E	.541	.551	.561	13.75	14.00	14.25
Overall Length	D	.541	.551	.561	13.75	14.00	14.25
Molded Package Width	E1	.463	.472	.482	11.75	12.00	12.25
Molded Package Length	D1	.463	.472	.482	11.75	12.00	12.25
Lead Thickness	c	.004	.006	.008	0.09	0.15	0.20
Lead Width	B	.007	.009	.011	0.17	0.22	0.27
Pin 1 Corner Chamfer	CH	.025	.035	.045	0.64	0.89	1.14
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MS-026
Drawing No. C04-092